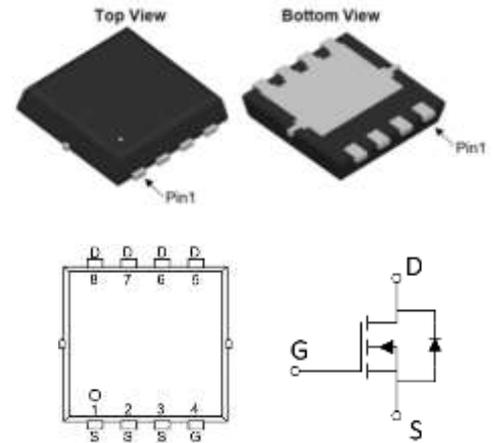


**40V<sub>DS</sub>/±20V<sub>GS</sub> N-Channel *Enhancement* Mode MOSFET**
**Features**

- V<sub>DS</sub>=40V, I<sub>D</sub>=100A
- R<sub>DS(ON)</sub>=3.5mΩ (TYP.) V<sub>GS</sub>=10V
- Reliable and Rugged
- Avalanche Rated
- Low On-Resistance
- High Current Capability

**Applications**

- Load Switch
- Power management in portable/desktop PCs
- DC/DC conversion

**PDFN5060**

**Ordering Information**

Device	package	Device Marking	Package Qty.
HMN40100D5	PDFN5060	N40100D5	5000/PCS

**Absolute Maximum Ratings** (T<sub>C</sub>=25°C, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V <sub>GS</sub> =0V)	V <sub>DS</sub>	40	V
Gate-Source Voltage (V <sub>GS</sub> =0V, static)	V <sub>GS</sub>	±20	V
Continuous Drain Current (T <sub>C</sub> =25°C)	I <sub>D</sub>	100	A
Continuous Drain Current (T <sub>C</sub> =100°C)		65	A
Pulsed Drain Current	I <sub>DM</sub>	400	A
Single Pulsed Avalanche Energy	E <sub>AS</sub>	150	mJ
V <sub>DS</sub> Spike 100ns	V <sub>SPIKE</sub>	43	V
Maximum Power Dissipation (T <sub>C</sub> =25°C)	P <sub>D</sub>	61	W
Operating, Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~150	°C

**Electrical Characteristics**

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	40	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V	-	-	1	μA
Gate -Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA	1.2	-	2.4	V
Drain-Source On-stage Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	-	3.5	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	-	5.4	

## Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	-	2.0	-	$^{\circ}C/W$

## Dynamic Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Input capacitance	$C_{iss}$	$V_{DS}=15V$	-	5594	-	pF
Output capacitance	$C_{oss}$	$V_{GS}=0V$	-	410	-	
Reverse transfer capacitance	$C_{rss}$	$f=1MHz$	-	339	-	
Gate Resistance	$R_g$	$f=1MHz$	-	-	-	$\Omega$
Total Gate Charge	$Q_g$	$V_{DS}=15V$	-	64	-	nC
Gate Source Charge	$Q_{gs}$	$V_{GS}=10V$	-	12.4	-	
Gate Drain Charge	$Q_{gd}$	$I_D=20A$	-	14	-	
Turn-on delay Time	$t_{d(on)}$	$V_{GS}=10V$	-	11	-	ns
Rise time	$t_r$	$V_{DS}=15V$	-	15	-	
Turn-off delay Time	$t_{d(off)}$	$R_L=0.75\Omega$	-	38	-	
Fall time	$t_f$	$R_G=3\Omega$	-	14	-	

## Reverse Diode Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Body Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_{SD}=1A$	-	-	1.2	V
Reverse Recovery Time	$t_{rr}$	$V_{GS}=0V, I_{SD}=20A$	-	22	-	ns
Reverse Recovery Charge	$Q_{rr}$	$d_i/d_t=500A/\mu s$	-	11	-	nC

## Electrical Characteristics Diagrames

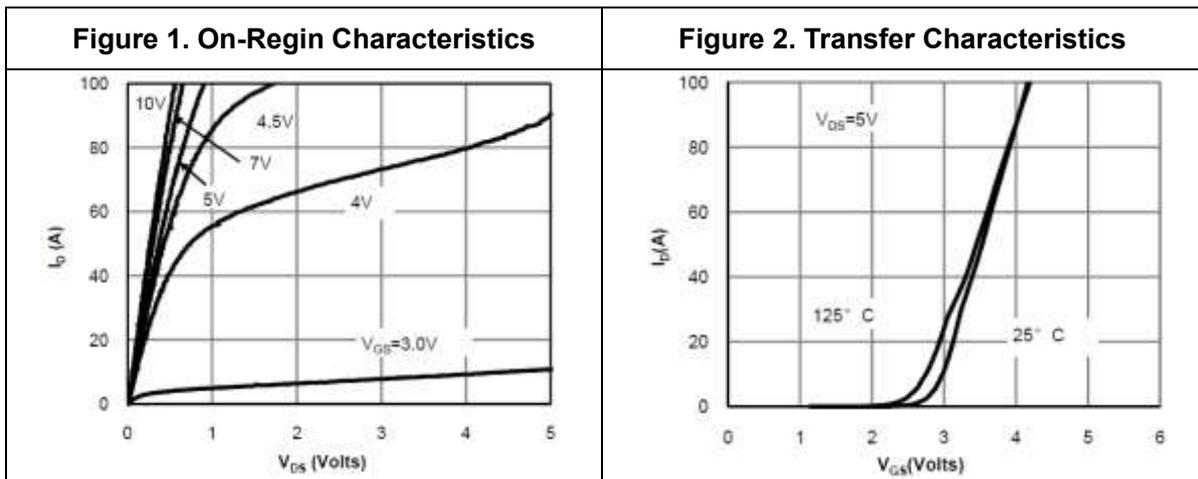


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

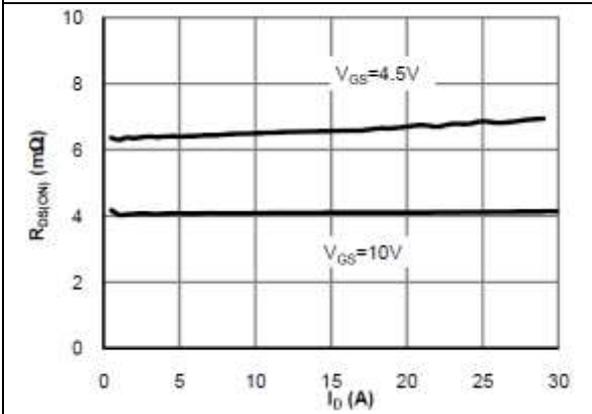


Figure 4. On-Resistance vs. Junction Temperature

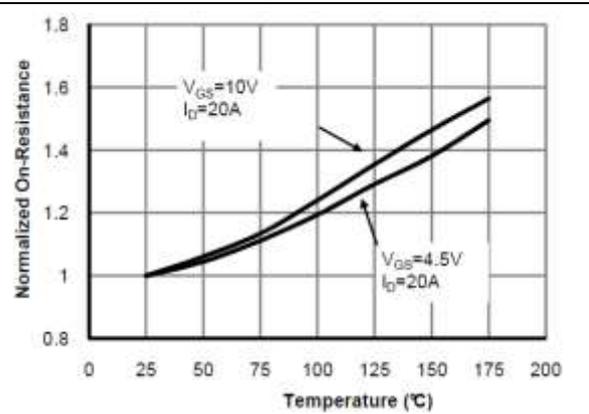


Figure 5. On-Resistance vs. Gate-Source Voltage

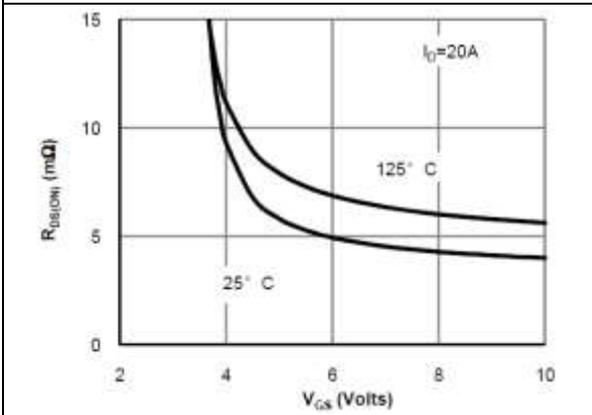


Figure 6. Body-Diode Characteristics

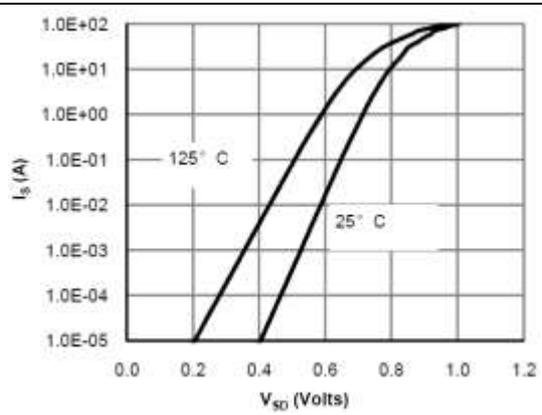


Figure 7. Gate-Charge Characteristics

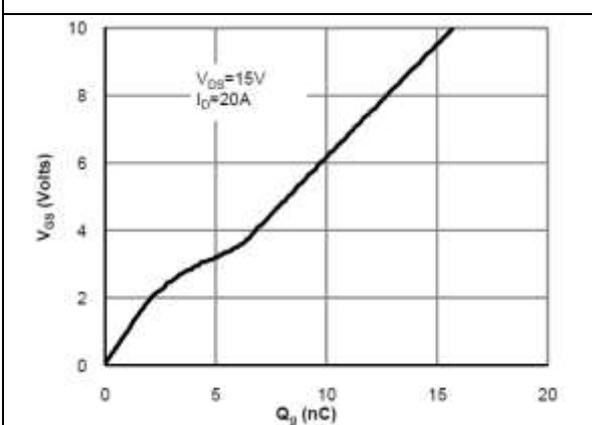
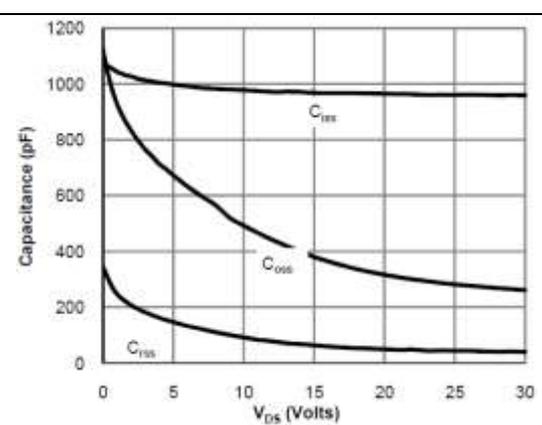
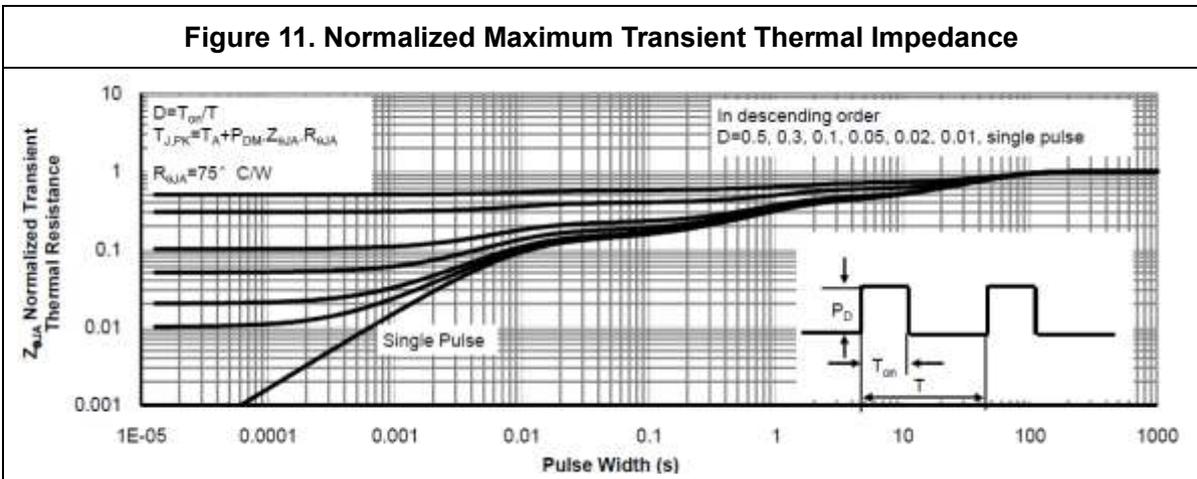
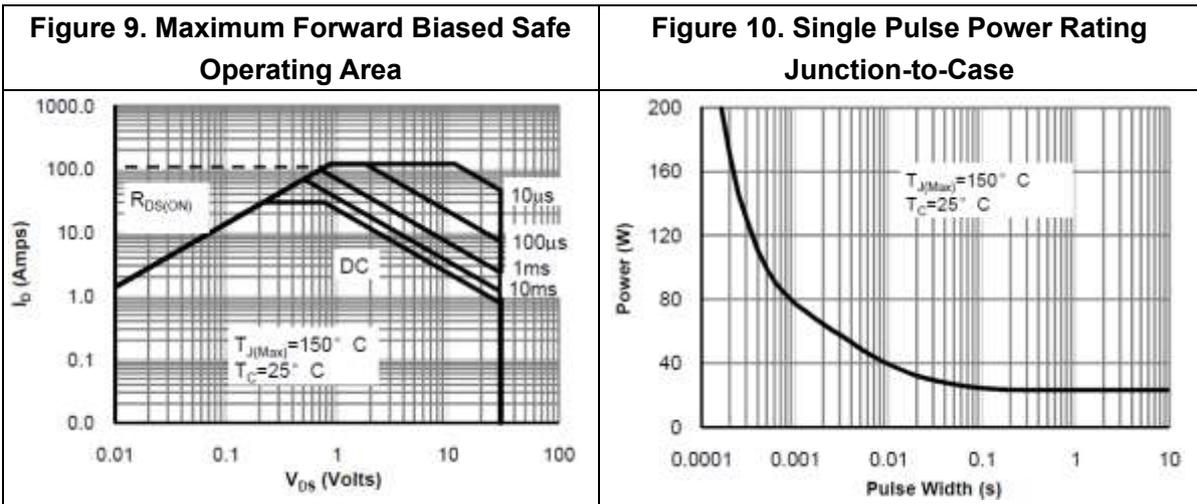


Figure 8. Capacitance Characteristics





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